

Comments and Corrections

Corrections to “A Modular Test-Suite for the Validation and Verification of Electromagnetic Solvers in Electromagnetic Compatibility Applications”

Ian D. Flintoft , John F. Dawson , Linda Dawson, Andrew C. Marvin, Jesus Alvarez, and S. G. García 

In [1], funding information should be added.

This work was supported in part by Spanish MINECO and by the EU FEDER under Project TEC2013-48414-C3-1-R.

REFERENCE

- [1] I. D. Flintoft *et al.*, “A modular test-suite for the validation and verification of electromagnetic solvers in electromagnetic compatibility applications,” *IEEE Trans. Electromagn. Compat.*, vol. 59, no. 1, pp. 111–118, Feb. 2017.

Manuscript received April 9, 2018. Date of publication May 2, 2018; date of current version May 29, 2018.

I. D. Flintoft, J. F. Dawson, L. Dawson, and A. C. Marvin are with the Department of Electronics, University of York, Heslington, York YO10 5DD, U.K. (e-mail: ian.flintoft@york.ac.uk; john.dawson@york.ac.uk; l.dawson@york.ac.uk; andy.marvin@york.ac.uk).

J. Alvarez is with the Airbus Defence and Space, 28906 Getafe, Spain (e-mail: jesus.g.alvarez@airbus.com).

S. G. Garcia is with the Department of Electromagnetism and Matter Physics, University of Granada, 18071 Granada, Spain (e-mail: salva@ugr.es).

Digital Object Identifier 10.1109/TEMC.2018.2826960